tML® - Cover w. integrated patchcord management and labeling strip for rack mount enclosures 19''/1U for 8 x modules

\*\*tML® - tde Modular Link

tML® is a patented, modular cabling system consisting of the three key components module, trunk cable and rack mount enclosure. The system components are 100 percent manufactured, pre-assembled and tested in Germany. They enable plug-and-play installation on site – especially in data centres, but also in industrial environments – within the shortest possible time. Heart of the system are the rear MPO/MTP® and Telco connectors, which can be used to connect at least six or twelve ports at a time. Depending on the module configuration, transfer rates of up to 200G are currently possible with SR4. The fibre optic and TP modules can be used together in a module carrier with a very high port density. The tde offers its tML® cabling system as a proven tML® standard system and in the highly innovative variants tML® Xtended, tML® 24 System and now tML® 32 System for extreme scalability and very easy migration to higher transmission rates such as 40G, 100G, 200G and 400G.

\*\*tML® - Rack Mount Enclosures 1U + Accessories

The Rack Mount Enclosure 19"/1U is for the equip of up to 8 x tML® - modules 1/2U with high component density.

\*\*TECHNISCHE\_DATEN

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| --- | --- |
| Material | steel, powdered |
| Color | black |
| Mounting | tool-less, snapping on the front of the rack mount enclosures (TML-19/1HE-8-M-2 / TML-19/1HE-8-M-3 / TML-19/1HE-8-M-A) |
| Dimensions | 19", 1U, depth 115mm |
|  | QS-Managementsystem ISO 9001, ISO 14001 and TL 9000 |